

# LIGHT EMITTING DIODE SPECIFICATION

CUSTOMER NAME:

DESCRIPTION: IE-2835O-SB-CE-0.7

REVISION: V2.2

ISSUE DATE: 2018-07-25

**Features:**

- Long operating life
- Superior thermal performance
- RoHS compliant and Pb free
- ESD protection

**Application:**

- Spot light
- Down light
- General lighting
- Architectural lighting
- Indoor and Outdoor Commercial lighting
- Special lighting

Part Number	Dice Material	Emitted Color	Lens Color
IE-2835O-SB-CE-0.7	AlGaInP	Orange	Water Clear

**Electro-Optical Characteristics**( $T_a=25^{\circ}\text{C}$ , @60mA)

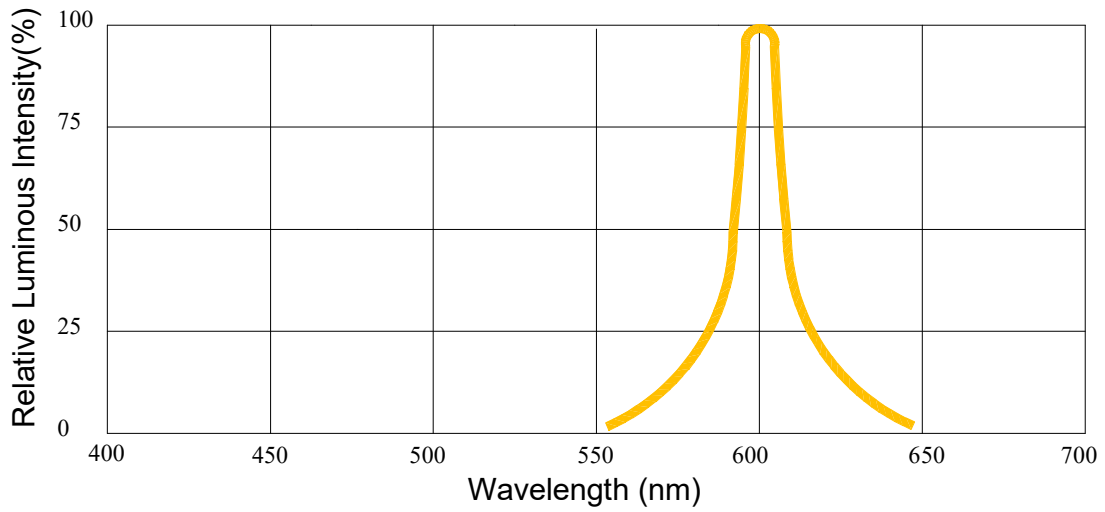
Parameter	Symbol	Min.	Typ.	Max.	Unit
Luminous Intensity	IV	1500	-	2000	mcd
Radiation Bandwidth	$\Delta\lambda$	-	20	-	nm
Forward Voltage	VF	1.90	2.00	2.40	v
Luminous Flux	$\Phi$	-	-	-	Lm
Dominant Wavelength	$\lambda_d$	600	605	610	nm
CIE Coordinates CIE	x,y	-	-	-	-
Color Temperature	Tc	-	-	-	k
Viewing Angle	$2\theta_{1/2}$	-	120	-	deg
Reverse Current	IR	-	-	10	uA

**Absolute Maximum Ratings**( $T_a=25^{\circ}\text{C}$ )

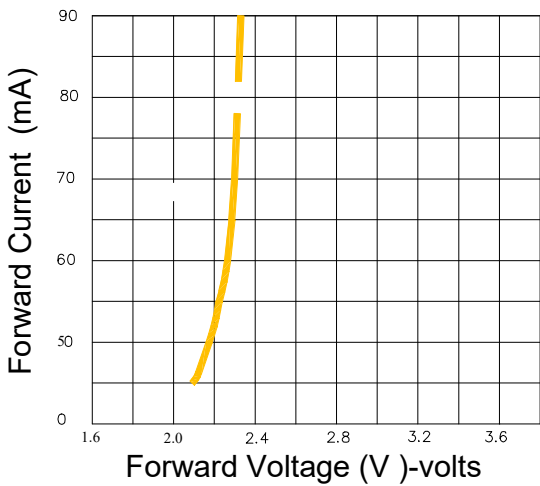
Parameter	Symbol	Max.	Unit
Peak Forward Current(1/10 Duty Cycle, 0.1ms Pulse Width)	IPF	100	mA
Forward Current	IF	60	mA
Reverse Voltage	VR	5	v
Electrostatic Discharge	ESD	2000	v
Operating Temperature Range	Topr	-40to+90	$^{\circ}\text{C}$
Storage Temperature Range	Tstg	-40to+90	$^{\circ}\text{C}$
Reflow Soldering	Tsld	260 $^{\circ}\text{C}$ for 10secs	

## Optical & Electrical Characteristics

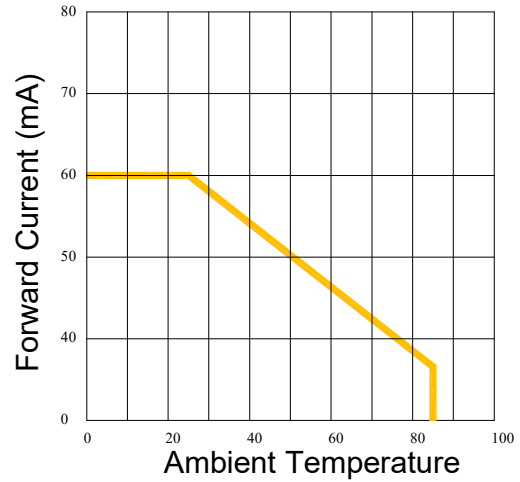
Spectrum Distribution



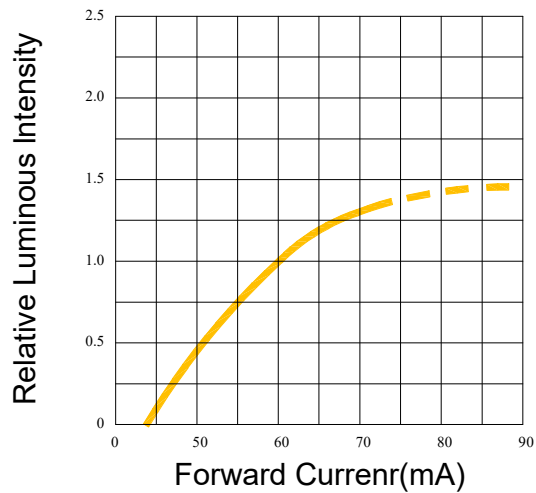
Forward Current vs. Forward Voltage



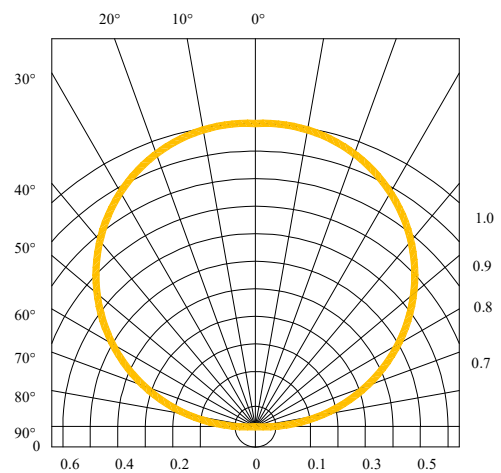
Forward Current vs. Ambient Temperature



Relative Luminous Intensity vs. Forward Current



Radiation Diagram



**Bin Limits****Bin Range Of Luminous Intensity (Unit:mcd)**

Bin Code	Min	Max	Condition
L1	1500	2000	IF=60mA
L2	-	-	
L3	-	-	

**Bin Range Of Forward Voltage (Unit:V)**

Bin Code	Min	Max	Condition
V1	1.9	2.0	IF=60mA
V2	2.0	2.1	
V3	2.1	2.2	
V4	2.2	2.3	
V5	2.3	2.4	

**Bin Range Of Wavelength (Unit:nm)**

Bin Code	Min	Max	Condition
O1	600	602	IF=60mA
O2	602	604	
O3	604	606	
O4	606	608	
O5	608	610	

Notes:

- 1.Tolerance of Luminous Intensity  $\pm 10\%$
- 2.Tolerance of Forward Voltage  $\pm 0.1V$

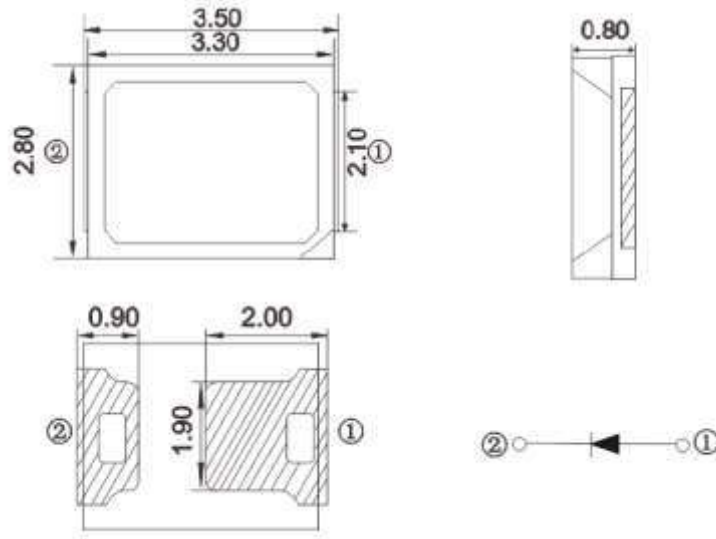
**Reliability Test Items And Conditions**

Test Items	Reference	Test Conditions	Time	Quantity	Criterion
Thermal Shock	MIL-STD-202G	-40°C (30min) -100°C (30min)	100 Cycles	22	0/22
Temperature And Humidity Cyclic	JEITA ED-4701 200 203	-10°C~65°C ; 0%~90%RH	10cycles	22	0/22
High Temperature Storage	JEITA ED -4071 200 201	Ta=100°C	1000H	22	0/22
Low Temperature Storage	JEITA ED -4071 200 202	Ta=-40°C	1000H	22	0/22
High Temperature High Humidity Storage	JEITA ED -4071 100 103	Ta=60°C ; RH=90%	1000H	22	0/22
High Temperature Life Test	JESD22-A108D	Ta=80°C	1000H	22	0/22
Life Test	JESD22-A108D	Ta=25°C IF=60mA	1000H	22	0/22
Resistance to Sodering Heat	GB/T 4937, II , 2.2&2.3	Tsol*=(240±5) °C10secs	2 times	22	0/22

**Criteria For Judging Damage**

Test Items	Symbol	Test Conditions	Criteria For Judging Damage
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =I <sub>FT</sub>	Initial Data±10%
Recerse Current	I <sub>R</sub>	V <sub>R</sub> =5V	I <sub>R</sub> ≤10uA
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> =I <sub>FT</sub>	Average I <sub>v</sub> degradation≤30%; Single LED I <sub>v</sub> degradation≤50%
Resistance to Soldering Heat	-	-	Meterial without internal cracks,no meterial between stripped,no deaded light

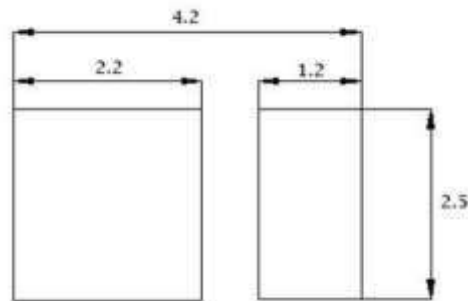
**Product size (Unit:mm)**



**NOTES:**

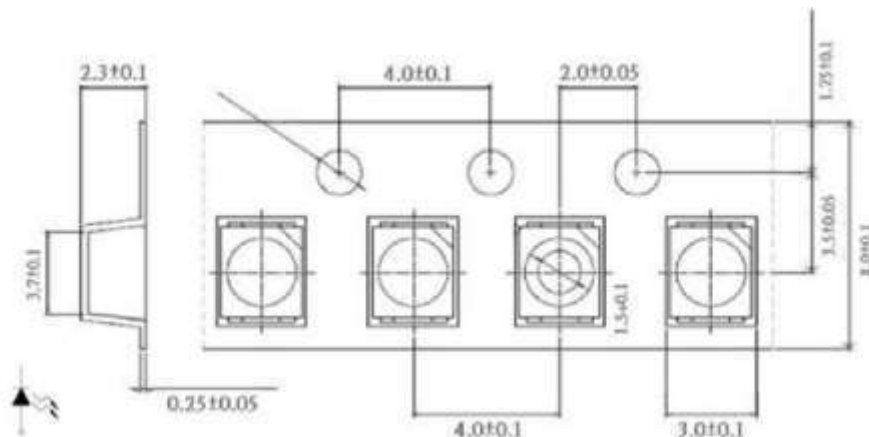
1. All dimensions are in millimeters (inches)
2. Tolerances are  $\pm 0.2\text{mm}$  (0.008inch) unless otherwise noted

**Recommended Soldering Pad Design (Unit:mm)**

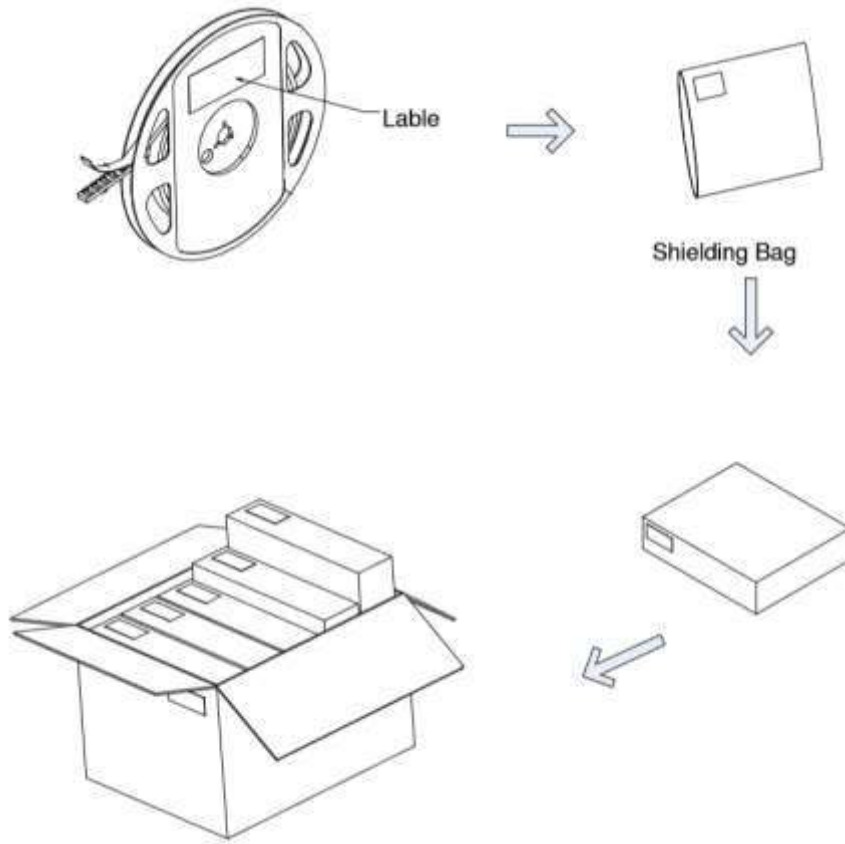


**Taping and package Spec**

•Tape Specification:2,000pcs Per Reel

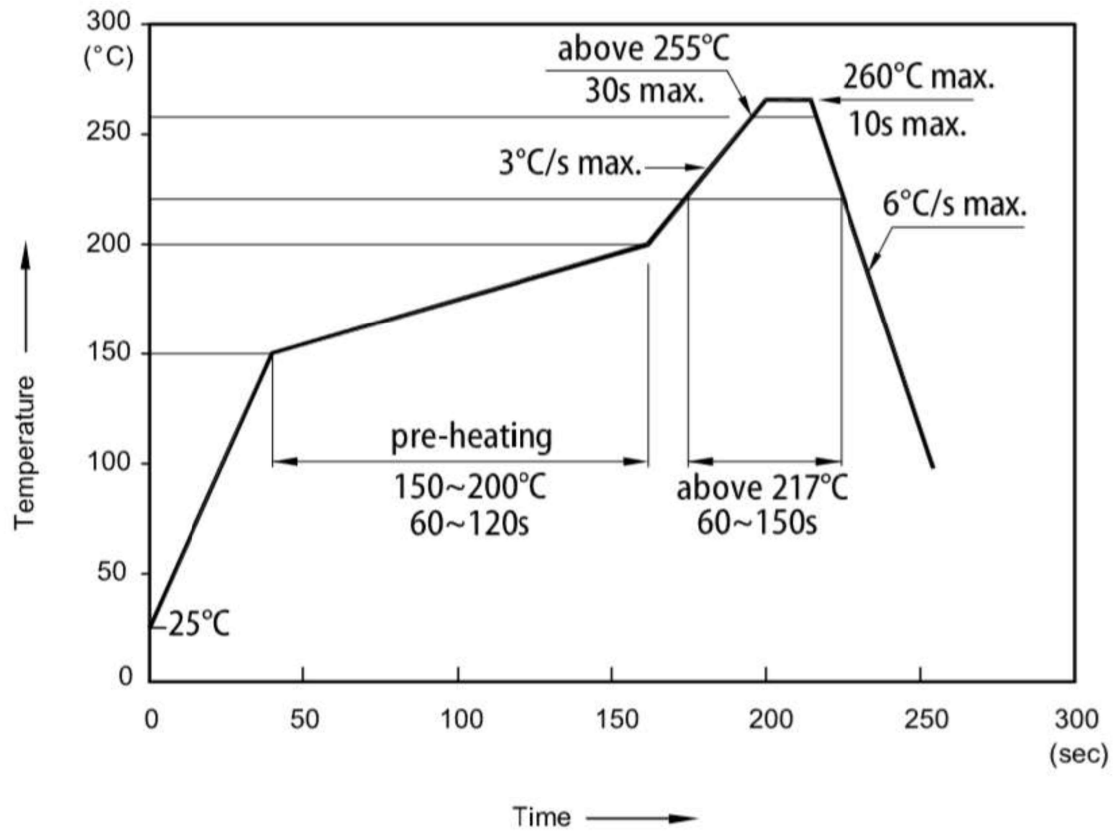


## Packaging



## Useful hint

### Reflow Soldering Instructions



1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

## Precautions

### 1. Storage :

- Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.
- Before opening the package, the product should be kept at 30°C or less and humidity less than 60% RH, and be used within a year.
- After opening the package, the product should be stored at 30 °C or less and humidity less than 10%RH, and be soldered within 24 hours (1day). It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.
- If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (70±5)°C for 24 hours.

### 2. Static Electricity:

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristics such as the forward voltage becoming lower, or the LEDs do not light at the low current, even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

### 3. Vulcanization :

LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag<sub>2</sub>S in the process. It will lead to the capacity of reflecting of silver layer reducing, light color temperature drift and serious decline, seriously affecting the performance of the product. So we should take corresponding measures to avoid vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.